International Rectifier

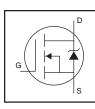
AUTOMOTIVE GRADE

AUIRFR4105Z AUIRFU4105Z

HEXFET® Power MOSFET

Features

- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *



V _{(BR)DSS}		55V
R _{DS(on)}	max.	24.5m Ω
I _D		30A

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low onresistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	30	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	21	Α
I _{DM}	Pulsed Drain Current ①	120	1
P _D @T _C = 25°C	Power Dissipation	48	W
	Linear Derating Factor	0.32	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②	29	mJ
E _{AS} (tested)	Single Pulse Avalanche Energy Tested Value ®	46	1
I _{AR}	Avalanche Current ①	See Fig.12a, 12b, 15, 16	Α
E _{AR}	Repetitive Avalanche Energy ©		mJ
TJ	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	1
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ®		3.12	
$R_{\theta JA}$	Junction-to-Ambient (PCB mount) ⑦		50	°C/W
$R_{\theta JA}$	Junction-to-Ambient		110	

HEXFET® is a registered trademark of International Rectifier.

Qualification standards can be found at http://www.in.com/

^{*}Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ $T_J = 25$ °C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.053		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		19	24.5	mΩ	V _{GS} = 10V, I _D = 18A ③
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
gfs	Forward Transconductance	16			S	$V_{DS} = 15V, I_{D} = 18A$
I _{DSS}	Drain-to-Source Leakage Current			20	μΑ	$V_{DS} = 55V, V_{GS} = 0V$
				250		$V_{DS} = 55V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-200]	V _{GS} = -20V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q _g	Total Gate Charge		18	27		I _D = 18A
Q_{gs}	Gate-to-Source Charge		5.3		nC	$V_{DS} = 44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		7.0		1	V _{GS} = 10V ③
t _{d(on)}	Turn-On Delay Time		10			$V_{DD} = 28V$
t _r	Rise Time		40		1	I _D = 18A
t _{d(off)}	Turn-Off Delay Time		26		ns	$R_G = 24.5 \Omega$
t _f	Fall Time		24		1	V _{GS} = 10V ③
L _D	Internal Drain Inductance		4.5			Between lead,
					nН	6mm (0.25in.)
L _S	Internal Source Inductance		7.5		1	from package
						and center of die contact
C _{iss}	Input Capacitance		740			$V_{GS} = 0V$
C _{oss}	Output Capacitance		140		1	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		74		pF	f = 1.0MHz
Coss	Output Capacitance		450		1	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C _{oss}	Output Capacitance		110		1	$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance		180		1	$V_{GS} = 0V$, $V_{DS} = 0V$ to 44V $\textcircled{4}$

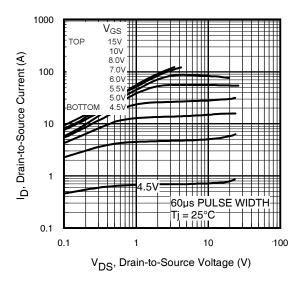
Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			30		MOSFET symbol
	(Body Diode)				Α	showing the
I _{SM}	Pulsed Source Current		_	120		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25$ °C, $I_S = 18A$, $V_{GS} = 0V$ ③
t _{rr}	Reverse Recovery Time		19	29	ns	$T_J = 25$ °C, $I_F = 18A$, $V_{DD} = 28V$
Q _{rr}	Reverse Recovery Charge		14	21	nC	di/dt = 100A/μs ③
t _{on}	Forward Turn-On Time	Intrinsio	turn-or	time is	negligib	le (turn-on is dominated by LS+LD)

Qualification Information[†]

		Automotive				
			(per AEC-Q101) ^{††}			
Qualification	on Level	Comments: This part number(s) passed Automotive qualification. IF Industrial and Consumer qualification level is granted by extension of thigher Automotive level.				
Maiatana Carathirita I arad		D-PAK	MSL1			
worsture 5	Sensitivity Level	I-PAK MSL1				
	Machine Model	Class M2 (200V)				
		AEC-Q101-002				
FOD	Human Body Model	Class H1A (500V)				
ESD			AEC-Q101-001			
	Charged Device	Class C5 (1125V)				
	Model	AEC-Q101-005				
RoHS Com	pliant	Yes				

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Exceptions to AEC-Q101 requirements are noted in the qualification report.



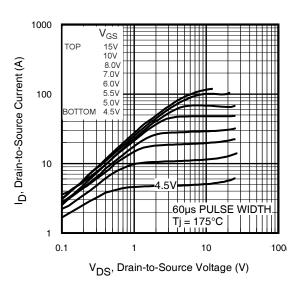
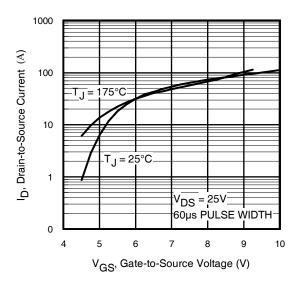


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



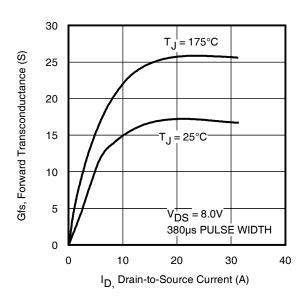
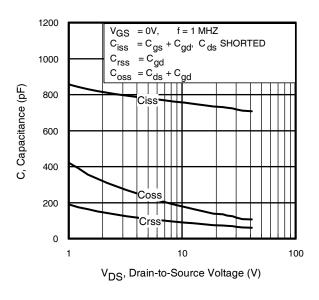


Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance Vs. Drain Current



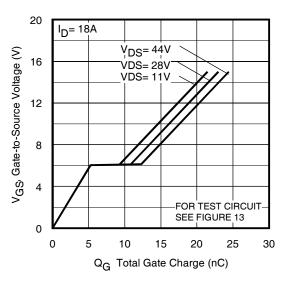
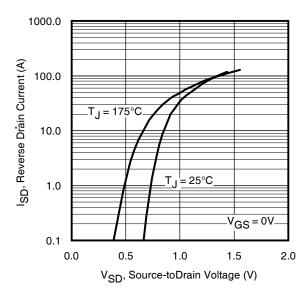


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage



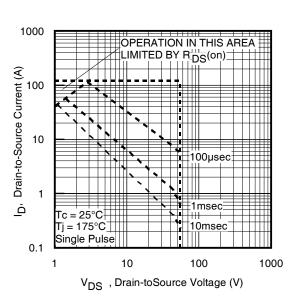


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

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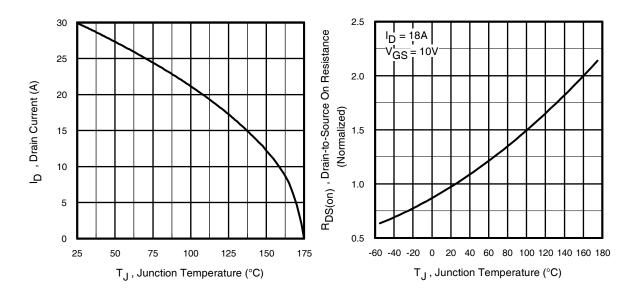


Fig 9. Maximum Drain Current Vs. Case Temperature

Fig 10. Normalized On-Resistance Vs. Temperature

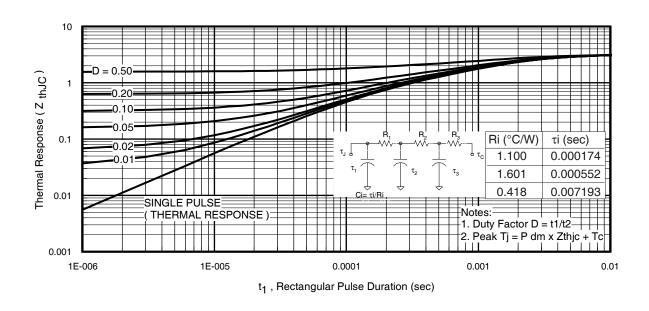


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

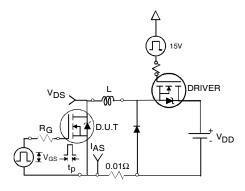


Fig 12a. Unclamped Inductive Test Circuit

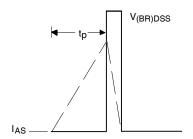


Fig 12b. Unclamped Inductive Waveforms

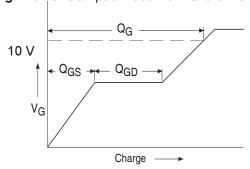


Fig 13a. Basic Gate Charge Waveform

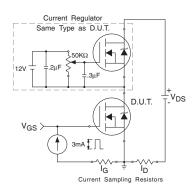


Fig 13b. Gate Charge Test Circuit www.irf.com

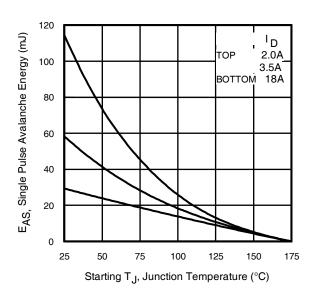


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

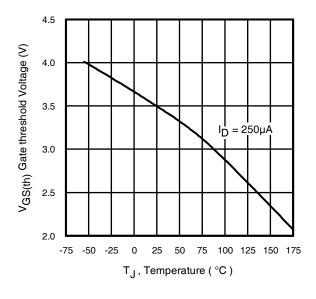


Fig 14. Threshold Voltage Vs. Temperature

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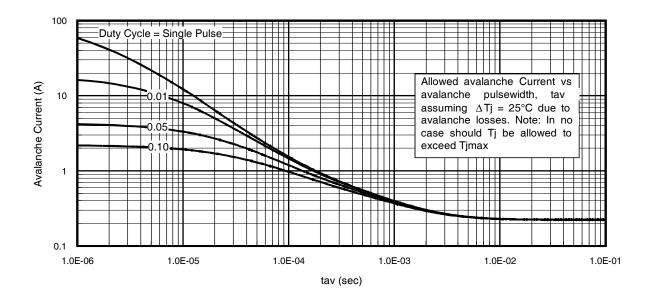


Fig 15. Typical Avalanche Current Vs. Pulsewidth

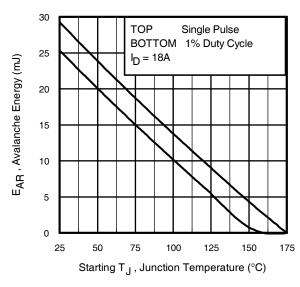


Fig 16. Maximum Avalanche Energy Vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- Avalanche failures assumption:
 Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- P_{D (ave)} = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).

 t_{av} = Average time in avalanche.

D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{thJC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \; (ave)} &= 1/2 \; (\; 1.3 \cdot BV \cdot I_{av}) = \triangle T / \; Z_{thJC} \\ I_{av} &= 2\triangle T / \; [1.3 \cdot BV \cdot Z_{th}] \\ E_{AS \; (AR)} &= P_{D \; (ave)} \cdot t_{av} \end{split}$$

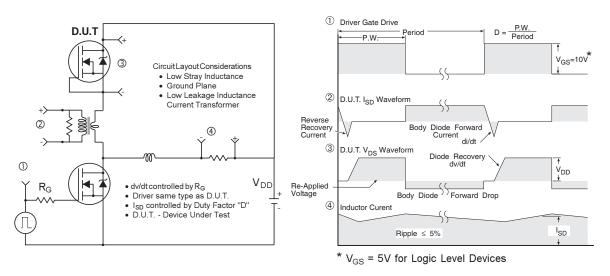


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

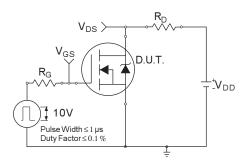


Fig 18a. Switching Time Test Circuit

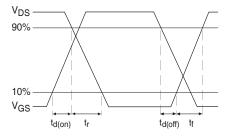


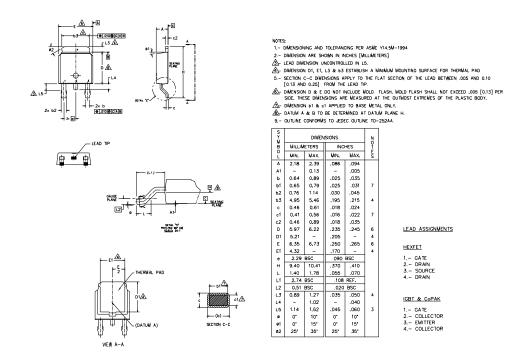
Fig 18b. Switching Time Waveforms

International

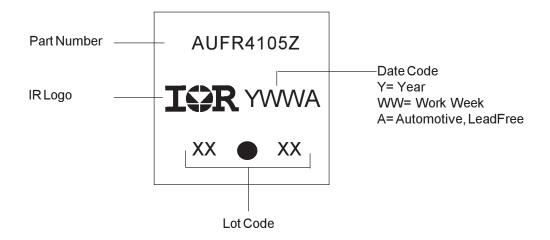
TOR Rectifier

D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)



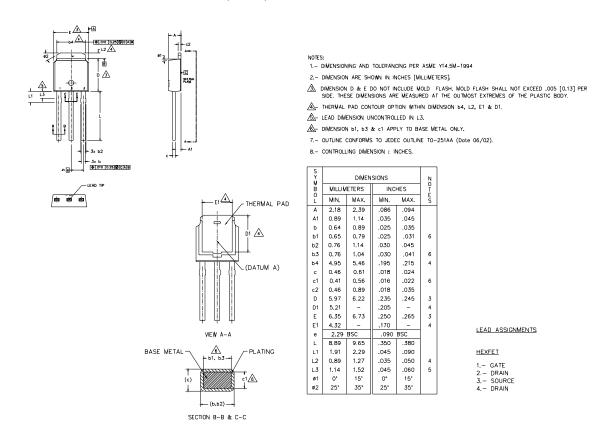
D-Pak Part Marking Information



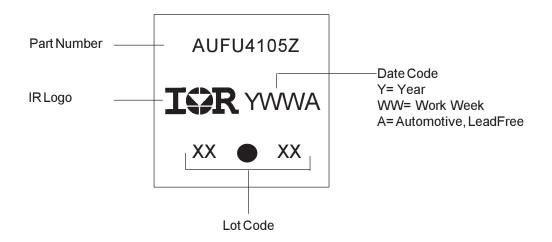
Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

I-Pak (TO-251AA) Package Outline

Dimensions are shown in millimeters (inches)



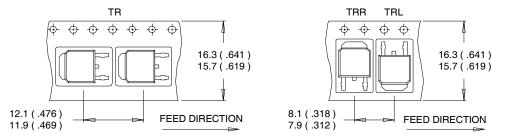
I-Pak Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/ www.irf.com

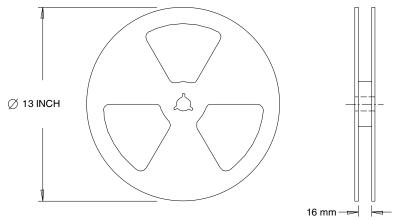
D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. OUTLINE CONFORMS TO EIA-481.

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- $R_G = 25\Omega$, $I_{AS} = 18A$, $V_{GS} = 10V$. Part not recommended for use above this value.
- ③ Pulse width \leq 1.0ms; duty cycle \leq 2%.
- ④ Coss eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- $\ \, \ \, \ \,$ Limited by T_{Jmax} , see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- \odot Limited by T_{Jmax} , starting $T_J = 25$ $^{\circ}$ C, L = 0.18mH \odot This value determined from sample failure population, starting $T_J = 25$ °C, L = 0.18mH, $R_G = 25\Omega$, $I_{AS} = 18A$, $V_{GS} = 10V$.
 - ① When mounted on 1" square PCB (FR-4 or G-10 Material) . For recommended footprint and soldering techniques refer to application note #AN-994.
 - ® RA is measured at TJ approximately 90°C.

International TOR Rectifier

AUIRFR/U4105Z

Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFR4105Z	Dpak	Tube	75	AUIRFR4105Z
		Tape and Reel	2000	AUIRFR4105ZTR
		Tape and Reel Left	3000	AUIRFR4105ZTRL
		Tape and Reel Right	3000	AUIRFR4105ZTRR
AUIRFU4105Z	lpak	Tube	75	AUIRFU4105Z

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